Unit: mm

.5±0.1

(0.8)

# 2SD2598

## Silicon NPN epitaxial planar type darlington

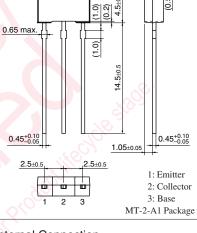
#### For low-frequency amplification

#### Features

- Forward current transfer ratio h<sub>FE</sub> is designed high, which is appropriate to the driver circuit of motors and printer hammer
- A shunt resistor is omitted from the driver.
- M type package, allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

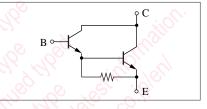
Absolute Maximum Ratings $T_a = 25^{\circ}C$					
Parameter	Symbol	Rating	Unit		
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	60	V		
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	V		
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V		
Collector current	Ι <sub>C</sub>	500	mA		
Peak collector current	I <sub>CP</sub>	750	mA		
Collector power dissipation *	P <sub>C</sub>	1	W		
Junction temperature	Tj	150	°Co		
Storage temperature	T <sub>stg</sub>	-55 to +150	°C		

Note) \*: Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion



#### Internal Connection

07



#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

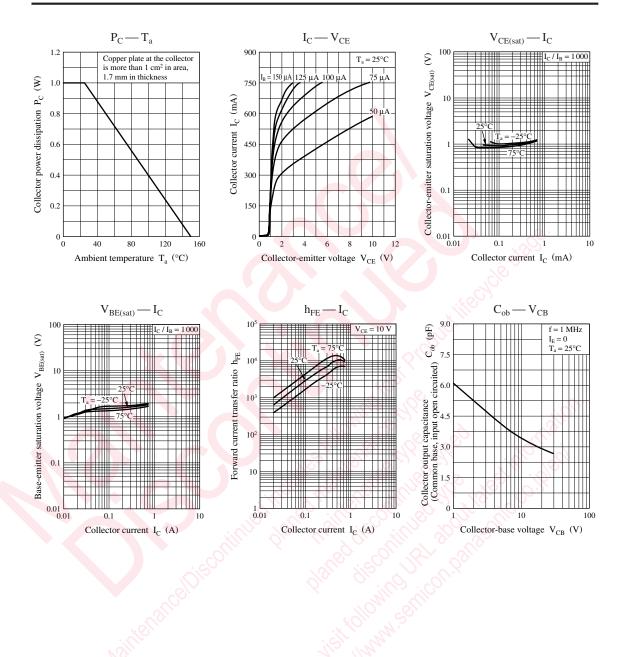
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 100 \ \mu A, I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 100 \ \mu A, I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 25 \text{ V}, I_E = 0$			100	nA
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 4 V, I_C = 0$			100	nA
Forward current transfer ratio *1, 2	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_C = 500 \text{ mA}$	4000		20000	_
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_{C} = 500 \text{ mA}, I_{B} = 0.5 \text{ mA}$			2.5	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 0.5 \text{ mA}$			3.0	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

*2: Rank classification				
Rank	Q	R		
$h_{FE}$	4000 to 10000	8000 to 20000		

### **Panasonic**



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